

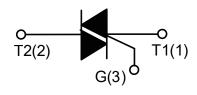
### **DESCRIPTION:**

The BT137S-800E SCR series with the parallel resistor between Gate and Cathode are especially recommended for use on straight hair, igniter, anion generator, etc.



#### **MAIN FEATURES**

Symbol	Value	Unit
I <sub>T(RMS)</sub>	8	А
V <sub>DRM</sub> /V <sub>RRM</sub>	600/800	V



### **ABSOLUTE MAXIMUM RATINGS**

Parameter			Symbol	Value	Unit
Storage junction temperature range			T <sub>stg</sub>	-40-150	$^{\circ}$
Operating junction temperature range			Tj	-40-125	$^{\circ}$ C
Repetitive peak off-state	te voltage	(T <sub>j</sub> =25℃)	$V_{DRM}$	600/800	V
Repetitive peak reverse	e voltage(	(T <sub>j</sub> =25℃)	$V_{RRM}$	600/800	V
RMS on-state current	TO-252 (T <sub>C</sub> =103°C) TO-263 (T <sub>C</sub> =85°C)		I <sub>T(RMS)</sub>	8	А
Non repetitive surge peak on-state current (full cycle, F=50Hz)			Ітѕм	65	А
I <sup>2</sup> t value for fusing (tp=10ms)			l <sup>2</sup> t	21	A <sup>2</sup> s
Peak gate current			lgм	2	А
Critical rate of rise of on-state current(I <sub>G</sub> =2×I <sub>GT</sub> )		I - II -III	-11/-1 <del>1</del>	50	Δ /
		IV	- dl/dt	10	⊢ A/μs
Average gate power dissipation			P <sub>G(AV)</sub>	0.5	W
Peak gate power			P <sub>GM</sub>	5	W



# **ELECTRICAL CHARACTERISTICS** (T<sub>j</sub>=25 °C unless otherwise specified)

Symbol	Test Condition	Quadrant		Value			Linit	
Symbol				D	Е	F	G	Unit
I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =30Ω	I - II -III	MAX	5	10	25	50	mA
IGI		IV		10	25	70	100	
V <sub>G</sub> T		ALL	MAX	1.3			V	
V <sub>GD</sub>	$V_D=V_{DRM}$ $T_j=125$ $^{\circ}$ C ALL RL=3.3KΩ		MIN	0.2			V	
IL	I <sub>G</sub> =1.2I <sub>GT</sub>	I -III	MAX	10	20	50	70	mA
		II -IV	IVIAA	20	30	70	100	IIIA
Ін	I <sub>T</sub> =100mA		MAX	10	15	40	60	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125℃		MIN	20	50	50	200	V/µs

## **STATIC CHARACTERISTICS**

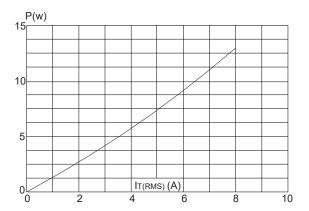
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>тм</sub> =10A tp=380µs	Tj=25℃	1.6	V
IDRM	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25℃	5	μA
I <sub>RRM</sub>		Tj=125℃	1	mA

## **THERMAL RESISTANCES**

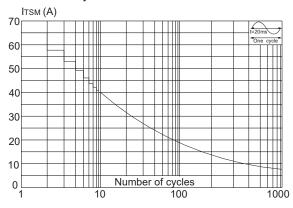
Symbol	Parameter		Value	Unit
D	D	TO-252 2.1		// //
R <sub>th(j-c)</sub> junction to case(AC)	TO-263	3.1	°℃/W	
R <sub>th(j-a)</sub> junction to ambient	TO-252 70		°c/W	
	juriction to ambient	TO-263	45	



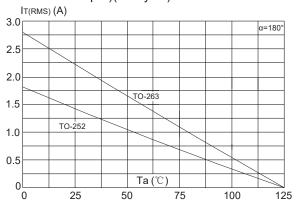
**FIG.1:** Maximum power dissipation versus RMS on-state current



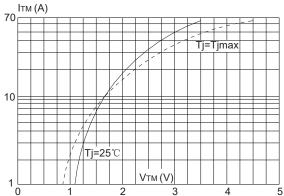
**FIG.3:** Surge peak on-state current versus number of cycles



**FIG.2:** RMS on-state current versus ambient temperature (printed circuit board FR4,copper thickness:35µm)(full cycle)

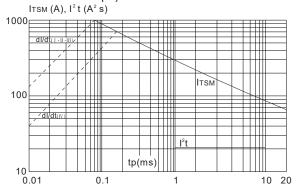


**FIG.4:** On-state characteristics (maximum values)

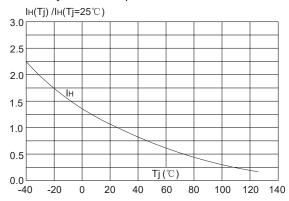




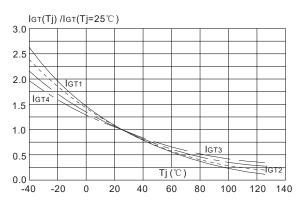
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponging value of  $I^2t$  ( I - II - III : dI/dt < 50A/ $\mu$ s; IV:dI/dt < 10A/ $\mu$ s)



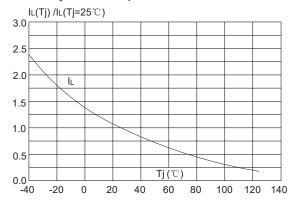
**FIG.7:** Relative variations of holding current versus junction temperature



**FIG.6:** Relative variations of gate trigger current versus junction temperature



**FIG.8:** Relative variations of latching current versus junction temperature





### **SOLDERING PARAMETERS**

Reflow Condition		Pb-Free assembly	
		(see figure at right)	
	-Temperature Min	+150°C	
	(T <sub>s(min)</sub> )	+130 C	
Pre	-Temperature Max	+200°C	
Heat	(T <sub>s(max)</sub> )	+200 C	
	-Time (Min to Max)	60-180 secs.	
	(ts)	00-100 secs.	
Average	ramp up rate	3°C/sec. Max	
(Liquidus	Temp (T <sub>L</sub> )to peak)	3 C/Sec. Max	
T <sub>s(max)</sub> to	T∟ - Ramp-up Rate	3℃/sec. Max	
	-Temperature(T∟)	+217℃	
Reflow	(Liquidus)	+217 C	
	-Temperature(t∟)	60-150 secs.	
Peak Ten	ոթ (T <sub>p</sub> )	+260(+0/-5)°C	
Time with	iin 5°Cof actual	20-40secs.	
Peak Ten	np (t <sub>p</sub> )	20-405ecs.	
Ramp-do	wn Rate	6℃/sec. Max	
Time 25°	to Peak Temp (T <sub>P</sub> )	8 min. Max	
Do not ex	cceed	+260℃	

